

## Heat Sink Compound - Grey *Ultra Max*™ Conductive 10g Syringe 3cc

### Product Highlights

- **Lead-Free / RoHS 3 Compliant / REACH Compliant**
- *Ultra Max*™ High-Density Thermal Paste. Grey, non-curing, flowable, thermally conductive heat sink compound. Heavily filled with heat-conductive metal oxide. Provides extremely high thermal conductivity, low bleed and high temperature stability.
- Electrically insulating ( $4 \times 10^{13}$  ohm-cm)



### Specifications

Viscosity:	87,000 cP (87,000 mPa·s)
Density:	2.5g/cc
Thermal Conductivity:	8.5 W/m·K
Thermal Resistance:	0.03 °C·cm²/W
Electrical Volume Resistivity:	$4 \times 10^{13}$ ohm-cm
Operating Temperature (Continuous):	-40 to 150°C (-40 to 302°F)
Operating Temperature (Peak):	200°C (392°F)
Size:	10g Syringe (3cc)

### Storage and Handling

Store refrigerated or at room temperature 3-25°C (37-77°F). Allow 4 hours for thermal paste to reach an application temperature of 20-25°C (68-77°F) before use.

### Shelf Life

>24 months

### Transportation

This product has no shipping restrictions. Shipping below 0°C (32°F) or above 25°C (77°F) for normal transit times by ground or air will not impact this product's stated shelf life.

Chip Quik® Thermal Paste Orderable Part Numbers

<b>Thermal Conductivity (W/m·K)</b>	<b>Thermal Resistance (°C·cm<sup>2</sup>/W)</b>	<b>Density (g/cc)</b>	<b>Color</b>	<b>Package</b>	<b>Size (g)</b>	<b>Orderable Part Number</b>
0.67	0.16	2.1	White	Syringe	10	TC1-10G
0.67	0.16	2.1	White	Syringe	20	TC1-20G
0.67	0.16	2.1	White	Jar	200	TC1-200G
4.3	0.06	2.5	Grey	Syringe	10	TC2-10G
4.3	0.06	2.5	Grey	Syringe	20	TC2-20G
4.3	0.06	2.5	Grey	Jar	50	TC2-50G
8.5	0.03	2.5	Grey	Syringe	1	TC3-1G
8.5	0.03	2.5	Grey	Syringe	3.5	TC3-3.5G
8.5	0.03	2.5	Grey	Syringe	10	TC3-10G